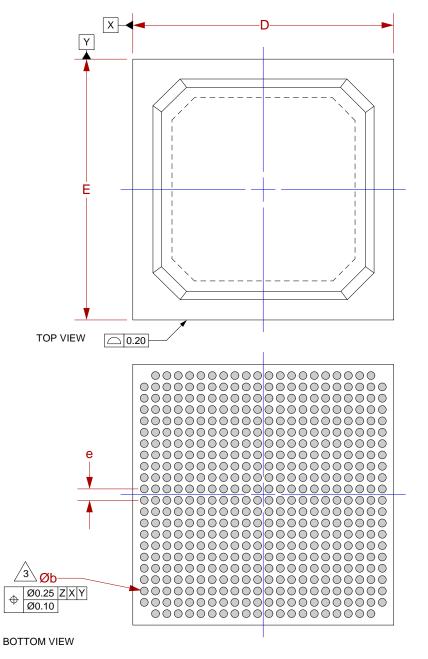


CBT-BGA-6006 Drawing		Status: Released	Scale	: 3:1	Rev: A
	© 2010 IRONWOOD ELECTRONICS, INC. Tele: (800) 404-0204 www.ironwoodelectronics.com	Drawing: S.Natarajan		Date: 12/18/2012	
		File: CBT-BGA-6006 Dwg		Modified:	

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.



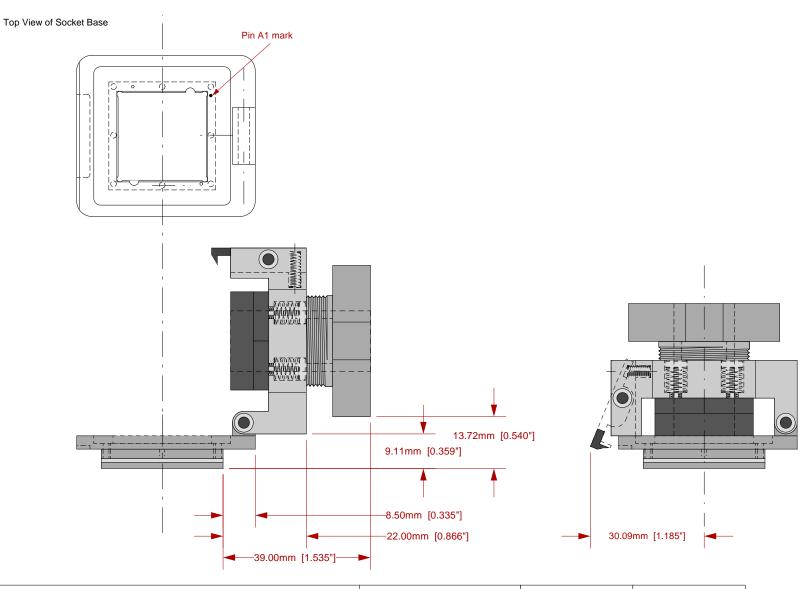
	-DETAIL		DETAIL	,	/ 5\
	A	A1	Z /4		0.35 Z 5 // 0.25 Z 2
SIDE VIEW					

- 1. Dimensions are in millimeters.
- Interpret dimensions and tolerances per ASME Y14.5M-1994.
- Dimension b is measured at the maximum solder ball diameter, parallel to datum plane Z.
- Datum Z (seating plane) is defined by the spherical crowns of the solder balls.
 - Parallelism measurement shall exclude any effect of mark on top surface of package.

DIM	MIN	MAX	
Α	1.85	2.11	
A1	0.3	0.5	
b		0.60	
D	23.00 BSC		
Е	23.00 BSC		
е	1.0 BSC		

Array 22x22 480 pos.

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All dimensions are in mm.
All tolerences are +/- 0.125mm.
(Unless stated otherwise)

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